

# 3A, 50V - 600V Ultra Fast Surface Mount Rectifier

#### **FEATURES**

- Glass passivated chip junction
- Ideal for automated placement
- Ultra fast recovery time for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

#### **APPLICATIONS**

- High frequency rectification
- Freewheeling application
- Switching mode converters and inverters in computer, and telecommunication

#### **MECHANICAL DATA**

- Case: DO-214AB (SMC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.210g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	UNIT			
I <sub>F</sub>	3	Α			
$V_{RRM}$	50 - 600	V			
I <sub>FSM</sub>	75	Α			
T <sub>J MAX</sub>	175	°C			
Package	DO-214AB (SMC)				
Configuration	Single die				









DO-214AB (SMC)



PARAMETER	SYMBOL	MUR	MUR	MUR	MUR	MUR	MUR	
		305S	3105	315S	<b>320S</b>	340S	360S	UNIT
Marking code on the device		MUR 305S	MUR 310S	MUR 315S	MUR 320S	MUR 340S	MUR 360S	
Repetitive peak reverse voltage	$V_{RRM}$	50	100	150	200	400	600	V
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	105	140	280	420	V
Forward current	l <sub>F</sub>	3				Α		
Peak forward surge current, 8.3ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	75				А		
Junction temperature	TJ	- 55 to +175				°C		
Storage temperature	T <sub>STG</sub>	- 55 to +175				°C		

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THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	UNIT		
Junction-to-lead thermal resistance	R <sub>eJL</sub>	11	°C/W		

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	MUR305S MUR310S MUR315S MUR320S	I <sub>F</sub> = 3A, T <sub>J</sub> = 25°C	V <sub>F</sub>	-	0.875	V
Forward voltage <sup>(1)</sup>	MUR340S MUR360S			-	1.250	V
	MUR305S MUR310S MUR315S MUR320S	I <sub>F</sub> = 3A, T <sub>J</sub> = 150°C	V <sub>F</sub>	-	0.710	V
	MUR340S MUR360S			-	1.050	٧
Reverse current @ rated V <sub>R</sub> <sup>(2)</sup>	MUR305S MUR310S MUR315S MUR320S	T <sub>J</sub> = 25°C	I <sub>R</sub>	-	5	μΑ
	MUR340S MUR360S			-	10	μA
	MUR305S MUR310S MUR315S MUR320S	T <sub>J</sub> = 150°C	I <sub>R</sub>	-	150	μΑ
	MUR340S MUR360S			-	250	μA
Reverse recovery time	MUR305S MUR310S MUR315S MUR320S	$I_F = 0.5A, I_R = 1.0A$ $I_{rr} = 0.25A$	t <sub>rr</sub>	-	25	ns
	MUR340S MUR360S	1 <sub>IT</sub> – 0.23A		-	50	ns

# Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION						
ORDERING CODE <sup>(1)</sup>	PACKAGE	PACKING				
MUR3xS	DO-214AB (SMC)	3,000 / Tape & Reel				

### Notes:

1. "x" defines voltage from 50V(MUR305S) to 600V(MUR360S)



### **CHARACTERISTICS CURVES**

(T<sub>A</sub> = 25°C unless otherwise noted)

**Fig.1 Forward Current Derating Curve** 

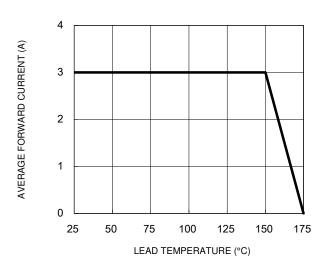


Fig.3 Typical Reverse Characteristics

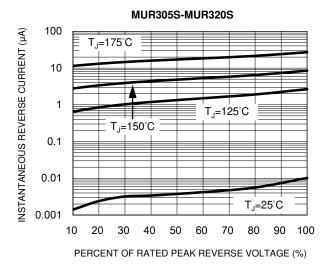


Fig.5 Typical Reverse Characteristics

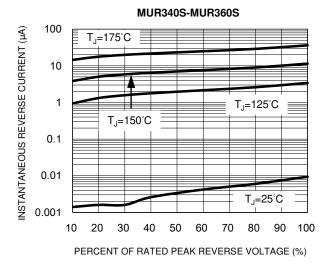


Fig.2 Typical Junction Capacitance

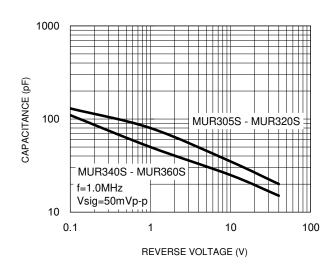


Fig.4 Typical Forward Characteristics

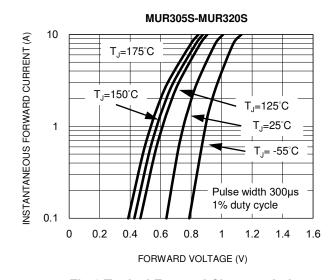
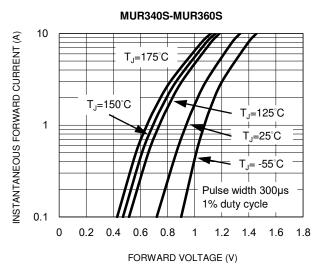


Fig.6 Typical Forward Characteristics

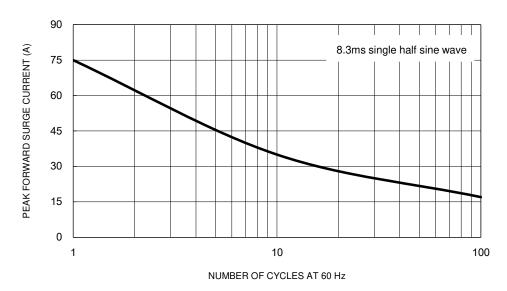




### **CHARACTERISTICS CURVES**

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$ 

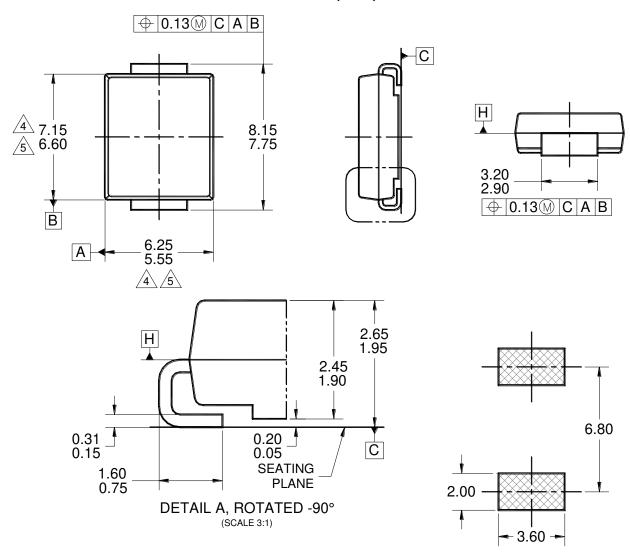
Fig.7 Maximum Non-Repetitive Forward Surge Current

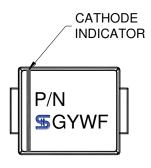




### **PACKAGE OUTLINE DIMENSIONS**

### DO-214AB (SMC)





### MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND

YW = DATE CODE F = FACTORY CODE

### NOTES: UNLESS OTHERWISE SPECIFIED

1. ALL DIMENSIONS ARE IN MILLIMETERS.

SUGGESTED PAD LAYOUT

- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- 3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AB, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
  - 6. DWG NO. REF: HQ2SD07-DO214SMC-036 REV A.



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